We report on the preparation of nanoscale ultra-thin Fe\textsubscript{65}Co\textsubscript{35} films of different thicknesses applied on Si/SiO\textsubscript{2} substrates with ion-beam deposition. Grazing incidence X-ray diffraction (GIXRD) was employed to characterize the microstructure of the Fe\textsubscript{65}Co\textsubscript{35} films. Magnetic hysteresis loops of the Fe\textsubscript{65}Co\textsubscript{35} films indicate good soft-magnetic properties of the films. We measured the transport properties of the films, and the behavior of resistance switching for more than an order of magnitude was obtained. The measurement performed on the ultra-thin Fe\textsubscript{65}Co\textsubscript{35} films reveal that the resistance-switching behavior is reversible and the transformation occurs between two stable resistant states. The modulation can be attributed to the anomalous Hall effect and the modification of the charge-carrier density at the interface.

Keywords: ferromagnetic film, resistance switching, anomalous Hall effect, carrier density

1 INTRODUCTION

In the field of spintronics, research on electronically controlled magnetism has received much attention.\textsuperscript{1} The coupling of resistance switching and magnetism is a typical example of electric control.\textsuperscript{2} Under the action of electric field, a dual control of resistance and magnetism of a device is realized.\textsuperscript{3} If resistance switching and magnetic switching are integrated in one device, the storage density of data can be greatly improved, and a multilevel storage of data can be realized.\textsuperscript{4} In a recent study, N. Spaldin et al.\textsuperscript{5} explained the possibility of using an electric field to directly adjust the magnetic properties of magnetic materials. The results show that the magneto-electric coupling effect can be realized without the need of an insulating layer, and a metal non-volatile memory can be constructed using the electromagnetic change of the Fe film.\textsuperscript{6} The Curie temperature of ferromagnetic metals and some alloys is higher than room temperature,\textsuperscript{7} and the direct modulation of magnetic properties with an electric field is of great significance for the realization of new memory devices.\textsuperscript{8} However, due to the electrostatic shielding of the metal under an electric field, the induced charge of the metal surface prevents the electric field from entering the inside of the conductor.\textsuperscript{9} The electric field can only exist at the atomic scale of the surface.\textsuperscript{10} Therefore, in an ultra-thin ferromagnetic metal film, the electric field may modulate the carrier density and electron configuration of the film,\textsuperscript{11} thus modulating the macroscopic magnetic properties.\textsuperscript{12} In this work, we report on the fabrication of ferromagnetic structures consisting of Fe\textsubscript{65}Co\textsubscript{35} thin films grown on Si/SiO\textsubscript{2} substrates. We discuss the resistance-switching behavior and transition mechanism of ferromagnetic metal films.

2 EXPERIMENTAL PART

An Fe\textsubscript{65}Co\textsubscript{35} alloy target was used and a thin film was deposited on a SiO\textsubscript{2}/Si substrate using ion-beam deposition. The film was deposited under a discharge voltage of 60 V, acceleration voltage of 200 V and beam voltage of 0.5 K. During the deposition process, argon gas was continuously injected and its flow was maintained at 5.7 cm\textsuperscript{3}/min. Thin films with thicknesses of (2, 5, 10, 15 and 20) nm were deposited. The microstructures of the prepared films were characterized with grazing incidence X-ray diffraction (GIXRD, BrukoDe8, Advance). An electron probe micro-analyzer (EPMA, JXA-8230) was
used for the elemental-composition analysis. A vibrating-sample magnetometer (VSM, Lake Shore 7404) was used to analyze the magnetic properties of the films. A semiconductor device analyzer (B1500A) was used to analyze the resistance-switching behavior. Transport properties were measured using the physical-property measurement system (ppms-9).

3 RESULTS AND DISCUSSION

Figure 1 shows the grazing incidence XRD diffraction patterns of the Fe$_{65}$Co$_{35}$ films with different thicknesses. Since the films were very thin, we used the grazing incidence method to characterize the crystal structure of the ultra-thin Fe$_{65}$Co$_{35}$ films. The body-centered cubic structure (bcc) of FeCo (110) was indexed from the diffraction peak that appeared near 45°. By comparison, it was found that as the thickness of the films increases from 2 nm to 20 nm, the diffraction peak near 45° becomes sharper, indicating that the film crystallinity is increasing. In addition, the EPMA test result showed that the Fe content in the Fe$_{65}$Co$_{35}$ film was about 65 %, and the Co content was about 35 %.

Figure 2 shows hysteresis loops for the Fe$_{65}$Co$_{35}$ thin films with thicknesses of (5, 10, 15 and 20) nm, while hysteresis loops are absent in the 2-nm thin films due to their thinness. It was found that with the increase in film thickness, the saturation-magnetization intensity gradually increased, and it was (0.76, 1.12, 2.01 and 2.11) emu/mm$^3$, for (5, 10, 15 and 20) nm Fe$_{65}$Co$_{35}$ films, respectively. The Fe$_{65}$Co$_{35}$ films exhibited coercive-force values of about (38, 41, 47 and 50) Gauss for (5, 10, 15 and 20) nm Fe$_{65}$Co$_{35}$ films, respectively, confirming that the prepared Fe$_{65}$Co$_{35}$ films had good soft-magnetic characteristics.

Curves I–V of the Fe$_{65}$Co$_{35}$ thin films were obtained. Figure 3 illustrates these curves of the Fe$_{65}$Co$_{35}$ films with thickness of (5, 10, 15 and 20) nm. The current as a function of voltage no longer exhibits the proportional relation behavior. For instance, for the 10-nm Fe$_{65}$Co$_{35}$ films, when the sweep voltage is 150 mV, the current increases steeply from 10 μA to above 110 μA, indicating the presence of the low-resistance state, and as the sweeping voltage increases to 200 mV, the current decreases sharply from 110 μA to about 10 μA, indicating that the sample was switched to the high-resistance state and the current changed substantially, proportionally to the voltage. In this regime, the current voltage develops a resistive switching behavior, producing more than an order-of-magnitude change in the resistance. It should be noted that the threshold voltage for the switch of the low-resistance state to the high-resistance state increases from 140 mV to about 300 mV when the film thickness increases from 5 nm to 20 nm. When a Fe$_{65}$Co$_{35}$ film is in contact with Si, a depletion layer (barrier layer) of carriers is formed on the surface of Si, a surface barrier appears and a region with a rectifying effect is formed. Its volt-ampere characteristic is similar to that of the p-n junction, showing a non-linear state.

Figure 4 shows the Hall resistivity of the (5, 10, 15 and 20) nm Fe$_{65}$Co$_{35}$ thin films at room temperature in
The research shows that in ferromagnetic metallic systems, the change in magnetism is often related to the carrier density. Due to the anomalous Hall effect on the surface of the Fe$_{65}$Co$_{35}$ film, the surface carrier density of the Fe$_{65}$Co$_{35}$ film changed when the Hall-effect test was performed, resulting in magnetic switching.

4 CONCLUSION

In summary, ultra-thin Fe$_{65}$Co$_{35}$ metal films were formed using ion-beam deposition on Si/SiO$_2$ substrates. Under the action of an electric field, electrical-resistance switching and magnetic switching occurred at the nano-level of the surfaces of the Fe$_{65}$Co$_{35}$ thin films. The electric-field-modulated transport behaviors are attributed to the density of the itinerant electrons in the metals.

5 REFERENCES


Table 1: Summary of Fe$_{65}$Co$_{35}$ thin films including thickness, temperature, resistivity, coefficient, mobility and type

<table>
<thead>
<tr>
<th>Thickness (nm)</th>
<th>Density (1/cm$^3$)</th>
<th>Resistivity ($\Omega \cdot cm$)</th>
<th>Coefficient ($cm^3/C$)</th>
<th>Mobility ($cm^2/V/S$)</th>
<th>Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>5</td>
<td>1.13×10$^{20}$</td>
<td>3.30×10$^4$</td>
<td>1.28×10$^{-3}$</td>
<td>1.42×10$^{-1}$</td>
<td>P</td>
</tr>
<tr>
<td>10</td>
<td>2.86×10$^{20}$</td>
<td>1.37×10$^5$</td>
<td>1.20×10$^{-2}$</td>
<td>1.60×10$^{-1}$</td>
<td>P</td>
</tr>
<tr>
<td>15</td>
<td>5.21×10$^{20}$</td>
<td>1.32×10$^5$</td>
<td>1.03×10$^{-2}$</td>
<td>7.81×10$^{-1}$</td>
<td>P</td>
</tr>
<tr>
<td>20</td>
<td>6.08×10$^{20}$</td>
<td>1.46×10$^5$</td>
<td>1.20×10$^{-2}$</td>
<td>8.18×10$^{-1}$</td>
<td>P</td>
</tr>
</tbody>
</table>

Figure 4: Hall resistivity of (5, 10, 15 and 20) nm Fe$_{65}$Co$_{35}$ thin films